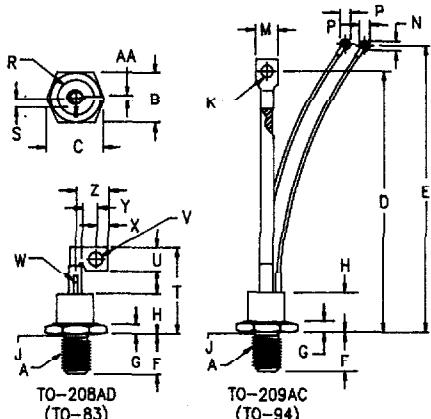


Silicon Controlled Rectifier Series 071



Note 1: 1/2-20 UNF-3A

Note 2: Full thread within 2 1/2 threads

Note 3: To specify package designation other than standard lead enter appropriate letter in place of "A".

"R" = Insulated lead

"D" = Flag Terminal

"C" = Top Stud (consult factory)

Dim.	Millimeter				1
	Minimum	Maximum	Minimum	Maximum	
A					
B	1.050	1.060	26.67	26.92	
C	---	1.161	---	29.49	
D	5.850	6.144	149.10	156.06	
E	6.850	7.375	173.99	187.33	
F	.797	.827	20.24	21.01	
G	.276	.286	.701	7.26	
H	---	.948	---	24.08	
J	.425	.499	10.80	12.67	2
K	.260	.280	6.60	7.11	Dia.
M	.500	.600	12.70	15.24	
N	.140	.150	3.56	3.81	
P	---	.295	---	7.49	
R	---	.900	---	22.86	
S	.225	.275	6.48	6.99	
T	---	1.750	---	44.45	
U	.370	.380	9.40	9.65	
V	.213	.223	5.41	5.66	Dia.
W	.065	.075	1.65	1.91	Dia.
X	.215	.225	5.46	5.72	
Y	.290	.315	7.37	8.00	
Z	.514	.530	13.06	13.46	
AA	.069	.099	2.26	2.51	

Microsemi Catalog Number	Forward & Reverse Repetitive Blocking	Reverse Transient Blocking
Standard Lead Flag Lead		
07102G0A	07102GOD	200
07103G0A	07103GOD	300
07104G0A	07104GOD	400
07105G0A	07105GOD	500
07106G0A	07106GOD	600
		300
		500
		600
		700

To specify dv/dt other than 200V/usec., contact factory.

- High dv/dt-200 V/usec.
- 1600 Amperes surge current
- Low forward on-state voltage
- Package conforming to either TO-209AC or TO-208AD outline
- Economical for general purpose phase control applications

Electrical Characteristics

Max. RMS on-state current	$I_{T(RMS)}$ 110 Amps	$T_C = 87^\circ\text{C}$
Max. average on-state cur.	$I_{T(AV)}$ 70 Amps	$T_C = 87^\circ\text{C}$
Max. peak on-state voltage	V_{TM} 1.6 Volts	$I_{TM} = 220 \text{ A(peak)}$
Max. holding current	I_H 200 mA	
Max. peak one cycle surge current	I_{TSM} 1600 A	$T_C = 87^\circ\text{C}, 60 \text{ Hz}$
Max. I^2t capability for fusing	I^2_t $10,624 \text{ A}^2\text{s}$	$t = 8.3 \text{ ms}$

Thermal and Mechanical Characteristics

Operating junction temp range	T_J	-40°C to 125°C
Storage temperature range	T_{STG}	-40°C to 150°C
Maximum thermal resistance	R_{TJC}	0.40°C/W Junction to case
Typical thermal resistance	R_{ECS}	0.20°C/W Case to sink
Max mounting torque		130 inch pounds maximum
Weight		071-G0A Approx. 3.6 ounces (102.0 grams) typical 071-G0D Approx. 3.24 ounces (91.8 grams) typical

**Microsemi Corp.
Colorado**

F-1.6

PH: 303-469-2161
FAX: 303-466-3775

Switching

Critical rate of rise of on state current (note 1)	di/dt	100A/usec.	$T_J = 125^\circ C$
Typical delay time (note 1)	t_d	3.0 usec.	
Typical circuit commuted turn-off time (note 2)	t_q	100 usec.	$T_J = 125^\circ C$

Note 1: $I_{TM} = 50A$, $V_D = V_{DRM}$, $V_{GT} = 12V$ open circuit, 20 ohm-0.1 usec. rise time
 Note 2: $I_{TM} = 50A$, $di/dt = 5A/\text{usec.}$, V_R during turn-off interval = 50V min.,
 reapplied $dv/dt = 20V/\text{usec.}$, linear to rated V_{DRM} , $V_{GT} = 0V$

Triggering

Max. gate voltage to trigger	V_{GT}	3.0V	$T_J = 25^\circ C$
Typical gate voltage to trigger	V_{GT}	1.0V	$T_J = 25^\circ C$
Max. nontriggering gate voltage	V_{GD}	0.25V	$T_J = 125^\circ C$
Max. gate current to trigger	I_{GT}	100mA	$T_J = 25^\circ C$
Typical gate current to trigger	I_{GT}	48mA	$T_J = 25^\circ C$
Max. peak gate power	PGM	15W	
Average gate power	$PG(AV)$	3.0W	$t_p = 10 \text{ usec.}$
Max. peak gate current	I_{GM}	4.0A	
Max. peak gate voltage (forward)	V_{GM}	10V	
Max. peak gate voltage (reverse)	V_{GM}	5.0V	

Blocking

Max. leakage current	I_{DRM}	10mA	$T_J = 125^\circ C \& V_{DRM}$
Max. reverse leakage	I_{RRM}	10mA	$T_J = 125^\circ C \& V_{RRM}$
Critical rate of rise of off-state voltage	dv/dt	200V/usec.	$T_J = 125^\circ C$

F

Figure 1
Typical Forward On-State Characteristics

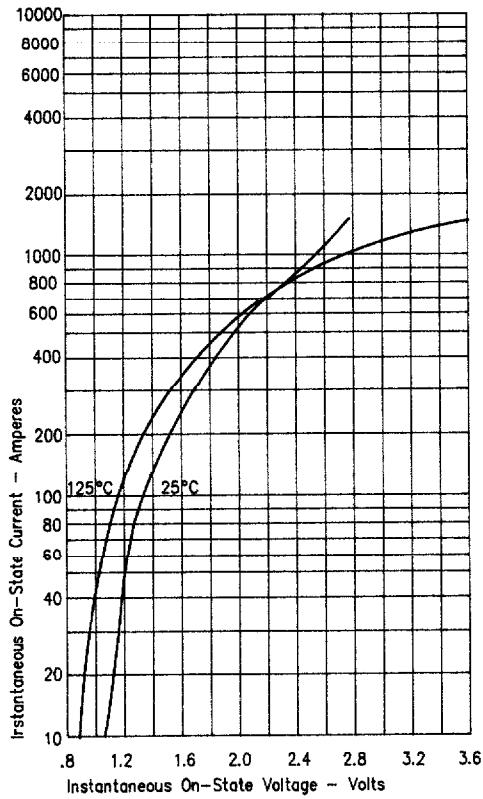


Figure 2
Forward Current Derating

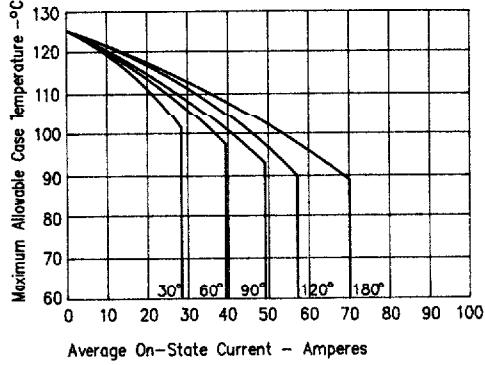


Figure 3
Maximum Power Dissipation

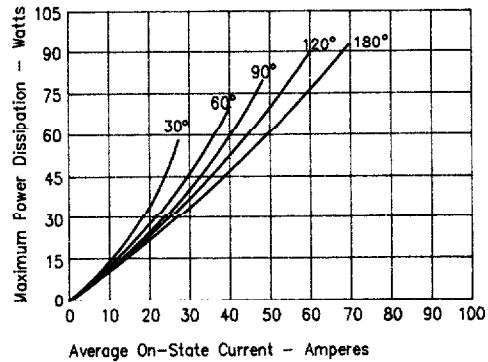


Figure 4
Transient Thermal Impedance

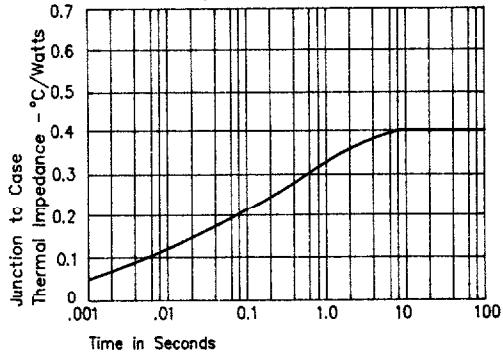


Figure 5
Maximum Nonrepetitive Surge Current

